INTEGRATED CIRCUITS

DATA SHEET

TDA8561Q 2×24 W BTL or 4×12 W single-ended car radio power amplifier

Product specification Supersedes data of 1997 Sep 22 File under Integrated Circuits, IC01 1999 Jun 30





2×24 W BTL or 4×12 W single-ended car radio power amplifier

TDA8561Q

FEATURES

- Requires very few external components
- · High output power
- · Flexibility in use; Quad single-ended or stereo BTL
- · Low output offset voltage
- · Fixed gain
- Diagnostic facility (distortion, short-circuit and temperature detection)
- · Good ripple rejection
- Mode select switch (operating, mute and standby)
- · Load dump protection
- AC and DC short-circuit safe to ground and to V_P
- · Low power dissipation in any short-circuit condition
- · Thermally protected

- Reverse polarity safe
- Electrostatic discharge protection
- No switch-on/switch-off plop
- · Flexible leads
- · Low thermal resistance
- Identical inputs (inverting and non-inverting).

GENERAL DESCRIPTION

The TDA8561Q is an integrated class-B output amplifier in a 17-lead single-in-line (SIL) power package. It contains 4×12 W Single-Ended (SE) or 2×24 W Bridge-Tied Load (BTL) amplifiers.

The device is primarily developed for car radio applications.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _P	positive operating supply voltage		6	14.4	18	V
I _{ORM}	repetitive peak output current		_	_	4	А
I _P	total quiescent current		_	80	_	mA
I _{sb}	standby current		_	0.1	100	μΑ
Stereo BTL a	pplication	•			•	
Po	output power	$R_L = 4 \Omega$; THD = 10%	_	24	_	W
RR	supply voltage ripple rejection		46	_	_	dB
V _{no}	noise output voltage	$R_s = 0 \Omega$	_	70	_	μV
Z _I	input impedance		25	_	_	kΩ
$ \Delta V_{O} $	DC output offset voltage		_	_	150	mV
Quad single-	ended application	•		•	•	•
Po	output power	THD = 10%				
		$R_L = 4 \Omega$	_	7	_	W
		$R_L = 2 \Omega$	_	12	_	W
RR	supply voltage ripple rejection		46	_	_	dB
V _{no}	noise output voltage	$R_s = 0 \Omega$	_	50	_	μV
$ z_i $	input impedance		50	_	_	kΩ

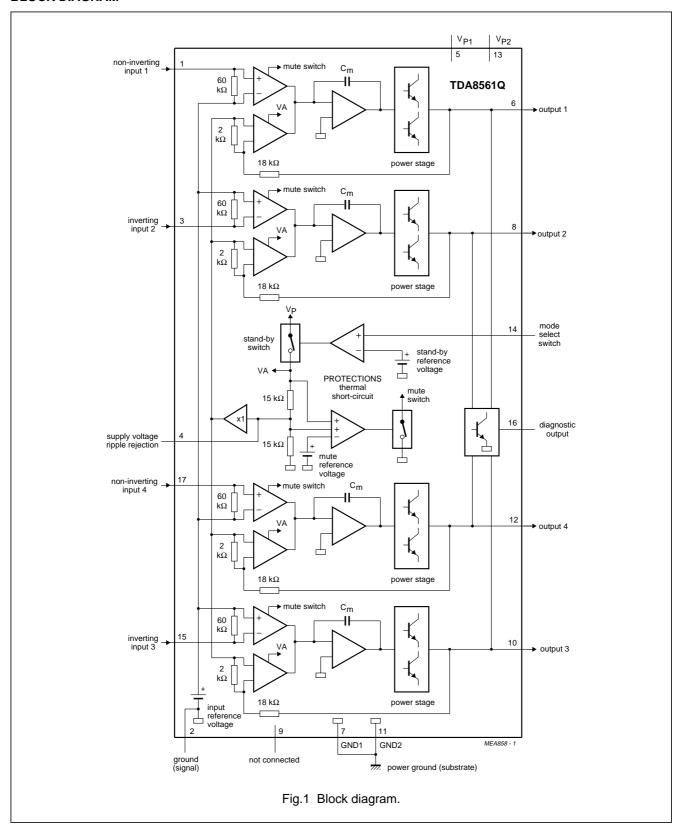
ORDERING INFORMATION

TYPE		PACKAGE	
NUMBER	NAME	DESCRIPTION	VERSION
TDA8561Q	DBS17P	plastic DIL-bent-SIL power package; 17 leads (lead length 12 mm)	SOT243-1

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BLOCK DIAGRAM

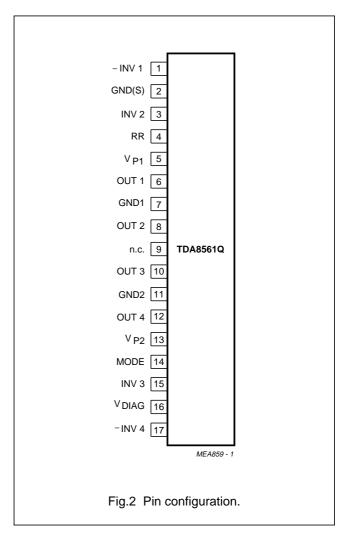


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PINNING

SYMBOL	PIN	DESCRIPTION	
-INV 1	1	non-inverting input 1	
GND(S)	2	signal ground	
INV 2	3	inverting input 2	
RR	4	supply voltage ripple rejection	
V _{P1}	5	supply voltage	
OUT 1	6	output 1	
GND1	7	power ground 1	
OUT 2	8	output 2	
n.c.	9	not connected	
OUT 3	10	output 3	
GND2	11	power ground 2	
OUT 4	12	output 4	
V _{P2}	13	supply voltage	
MODE	14	mode select switch input	
INV 3	15	inverting input 3	
V _{DIAG}	16	diagnostic output	
-INV 4	17	non-inverting input 4	



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FUNCTIONAL DESCRIPTION

The TDA8561Q contains four identical amplifiers and can be used for Single-Ended (SE) or Bridge-Tied Load (BTL) applications. The gain of each amplifier is fixed at 20 dB (26 dB in BTL). Special features of the device are:

Mode select switch (pin 14)

- Low standby current (<100 μA)
- · Low switching current (low cost supply switch)
- · Mute facility.

To avoid switch-on plops, it is advised to keep the amplifier in the mute mode during ≥100 ms (charging of the input capacitors at pins 1, 3, 15 and 17). This can be achieved by:

- Microcontroller control
- External timing circuit (see Fig.11).

Diagnostic output (pin 16)

DYNAMIC DISTORTION DETECTOR (DDD)

At the onset of clipping of one or more output stages, the dynamic distortion detector becomes active and pin 16 goes LOW. This information can be used to drive a sound processor or DC volume control to attenuate the input signal and thus limit the distortion. The output level of pin 16 is independent of the number of channels that are clipping (see Figs 3 and 4).

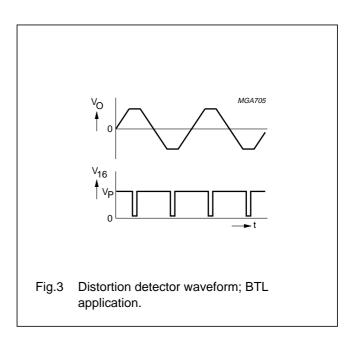
SHORT-CIRCUIT PROTECTION

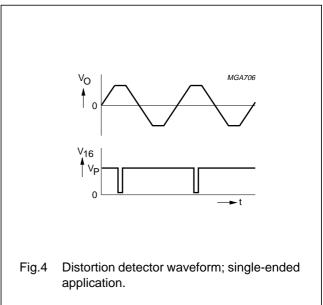
When a short-circuit occurs at one or more outputs to ground or to the supply voltage, the output stages are switched off until the short-circuit is removed and the device is switched on again, with a delay of approximately 20 ms, after removal of the short-circuit. During this short-circuit condition, pin 16 is continuously LOW.

When a short-circuit across the load of one or both channels occurs the output stages are switched off for approximately 20 ms. After that time it is checked during approximately 50 μs to see whether the short-circuit is still present. Due to this duty cycle of 50 $\mu s/20$ ms the average current consumption during this short-circuit condition is very low (approximately 40 mA).

During this short-circuit condition, pin 16 is LOW for 20 ms and HIGH for 50 μs (see Fig.5).

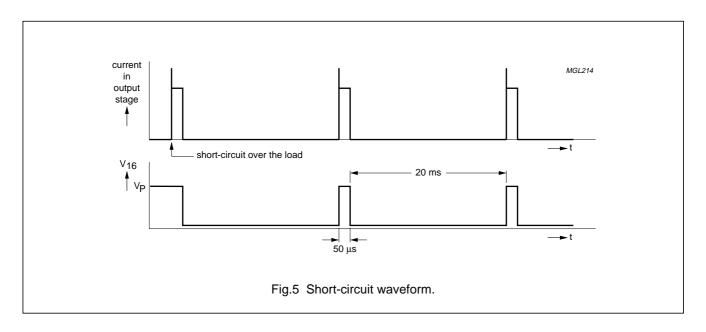
The power dissipation in any short-circuit condition is very low.





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TEMPERATURE DETECTION

When the virtual junction temperature $T_{\nu j}$ reaches 150 °C, pin 16 will be active LOW.

OPEN-COLLECTOR OUTPUT

Pin 16 is an open-collector output, which allows pin 16 of more devices being tied together.

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _P	positive supply voltage				
	operating		_	18	V
	non-operating		_	30	V
	load dump protection	during 50 ms; $t_r \ge 2.5$ ms	_	45	V
I _{OSM}	non-repetitive peak output current		_	6	Α
I _{ORM}	repetitive peak output current		_	4	Α
T _{stg}	storage temperature		-55	+150	°C
T _{amb}	operating ambient temperature		-40	+85	°C
T _{vj}	virtual junction temperature		_	150	°C
V _{psc}	AC and DC short-circuit safe voltage		_	18	V
V _{pr}	reverse polarity		_	6	V
P _{tot}	total power dissipation		_	60	W

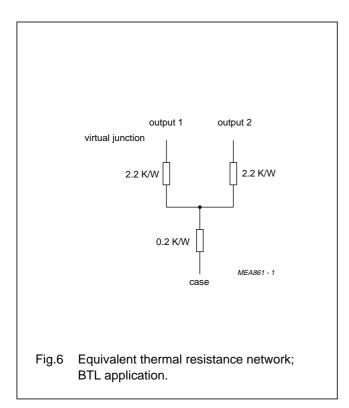
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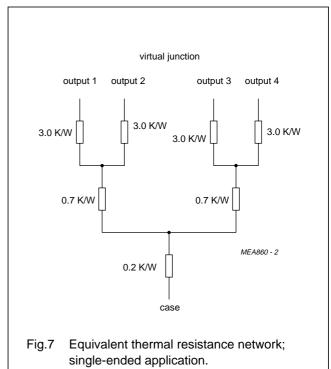
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THERMAL CHARACTERISTICS

In accordance with IEC 747-1.

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient in free air	40	K/W
R _{th j-c}	thermal resistance from junction to case (see Figs 6 and 7)	1.3	K/W





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DC CHARACTERISTICS

 V_P = 14.4 V; T_{amb} = 25 °C; measured in Fig.8; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply	•		•	•	•	-
V _P	positive supply voltage	note 1	6	14.4	18	V
l _Р	total quiescent current		_	80	160	mA
Vo	DC output voltage	note 2	_	6.9	_	V
$ \Delta V_{O} $	DC output offset voltage		_	_	150	mV
Mode select	switch	•	•			-
V _{on}	switch-on voltage level		8.5	_	_	V
MUTE CONDIT	ION			•	•	•
V _{mute}	mute voltage		3.3	_	6.4	V
Vo	output voltage in mute position	$V_{lmax} = 1 \text{ V; } f = 1 \text{ kHz}$	_	_	2	mV
$ \Delta V_{O} $	DC output offset voltage (between pins 6 to 8 and 10 to 12)		_	_	150	mV
STANDBY CON	DITION		•	•	•	-
V _{sb}	standby voltage		0	_	2	V
I _{sb}	standby current		_	_	100	μΑ
I _{sw}	switch-on current		_	12	40	μΑ
Diagnostic o	output (pin 16)					
V _{DIAG}	diagnostic output voltage	any short-circuit or clipping	-	-	0.6	V

Notes

- 1. The circuit is DC adjusted at V_P = 6 to 18 V and AC operating at V_P = 8.5 to 18 V.
- 2. At 18 V < $V_P <$ 30 V the DC output voltage $\leq\!0.5V_P.$

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AC CHARACTERISTICS

 V_P = 14.4 V; R_L = 4 $\Omega;$ f = 1 kHz; T_{amb} = 25 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Stereo BTL	. application (measured in Fig.8)		-			
P _o	output power	note 1				
		THD = 0.5%	15	19	_	W
		THD = 10%	20	24	_	W
THD	total harmonic distortion	P _o = 1 W	 -	0.06	_	%
Po	output power	V _P = 13.2 V				
		THD = 0.5%	_	16	_	W
		THD = 10%	-	20	_	W
В	power bandwidth	THD = 0.5%;	_	20 to	_	Hz
		$P_0 = -1$ dB; with respect to 15 W		15000		
f _l	low frequency roll-off	at -1 dB; note 2	_	45	_	Hz
f _h	high frequency roll-off	at –1 dB	20	_	_	kHz
G _v	closed loop voltage gain		25	26	27	dB
SVRR	supply voltage ripple rejection	note 3				
	on		48	_	_	dB
	mute		46	_	_	dB
	standby		80	_	_	dB
Z _I	input impedance		25	30	38	kΩ
V _{no}	noise output voltage					
	on	$R_s = 0 \Omega$; note 4	_	70	_	μV
	on	$R_s = 10 \text{ k}\Omega$; note 4	_	100	200	μV
	mute	notes 4 and 5	_	60	_	μV
α_{cs}	channel separation	$R_s = 10 \text{ k}\Omega$	40	60	_	dB
$ \Delta G_v $	channel unbalance		_	_	1	dB
DYNAMIC DIS	STORTION DETECTOR					
THD	total harmonic distortion	V ₁₆ ≤ 0.6 V; no short-circuit	_	10	_	%
Quad single	e-ended application (measured	in Fig.9)	•	•		
Po	output power	note 1				
		THD = 0.5%	4	5	_	W
		THD = 10%	5.5	7	_	W
THD	total harmonic distortion	P _o = 1 W	_	0.06	_	%
Po	output power	$R_L = 2 \Omega$; note 1				
		THD = 0.5%	7.5	10	_	W
		THD = 10%	10	12	_	W
f _l	low frequency roll-off	at -1 dB; note 2	_	25	_	Hz
f _h	high frequency roll-off	at –1 dB	20	1-	_	kHz
G _v	closed loop voltage gain		19	20	21	dB

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SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
SVRR	supply voltage ripple rejection	note 3				
	on		48	_	_	dB
	mute		46	_	_	dB
	standby		80	_	_	dB
Z _I	input impedance		50	60	75	kΩ
V _{no}	noise output voltage					
	on	$R_s = 0 \Omega$; note 4	_	50	_	μV
	on	$R_s = 10 \text{ k}\Omega$; note 4	_	70	100	μV
	mute	notes 4 and 5	_	50	_	μV
$\alpha_{ t CS}$	channel separation	$R_s = 10 \text{ k}\Omega$	40	60	_	dB
$ \Delta G_v $	channel unbalance		_	_	1	dB
DYNAMIC DIS	TORTION DETECTOR					
THD	total harmonic distortion	V ₁₆ ≤ 0.6 V; no short-circuit	_	10	_	%

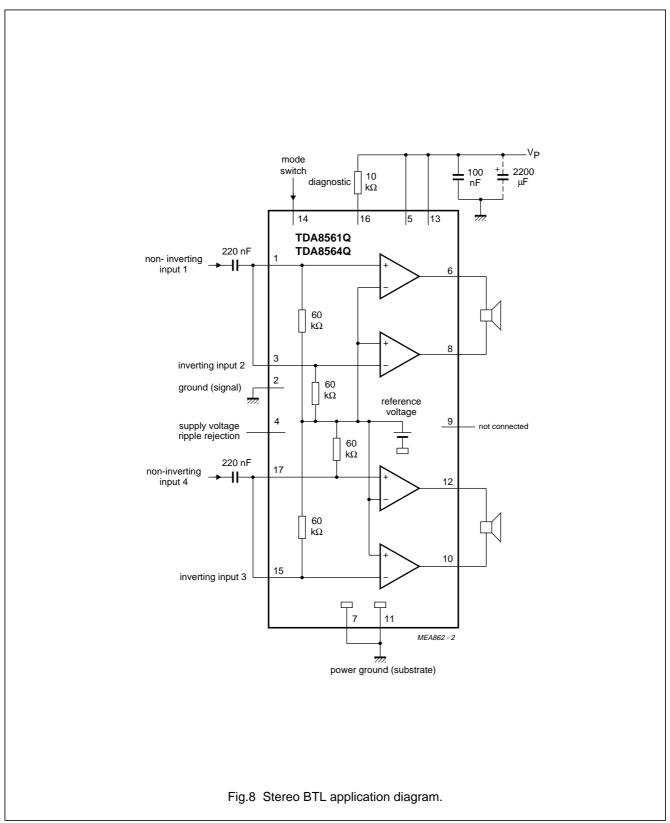
Notes

- 1. Output power is measured directly at the output pins of the IC.
- 2. Frequency response externally fixed.
- 3. Ripple rejection measured at the output with a source impedance of 0 Ω , maximum ripple amplitude of 2 V (p-p) and at a frequency of between 100 Hz and 10 kHz.
- 4. Noise measured in a bandwidth of 20 Hz to 20 kHz.
- 5. Noise output voltage independent of R_s ($V_i = 0 V$).

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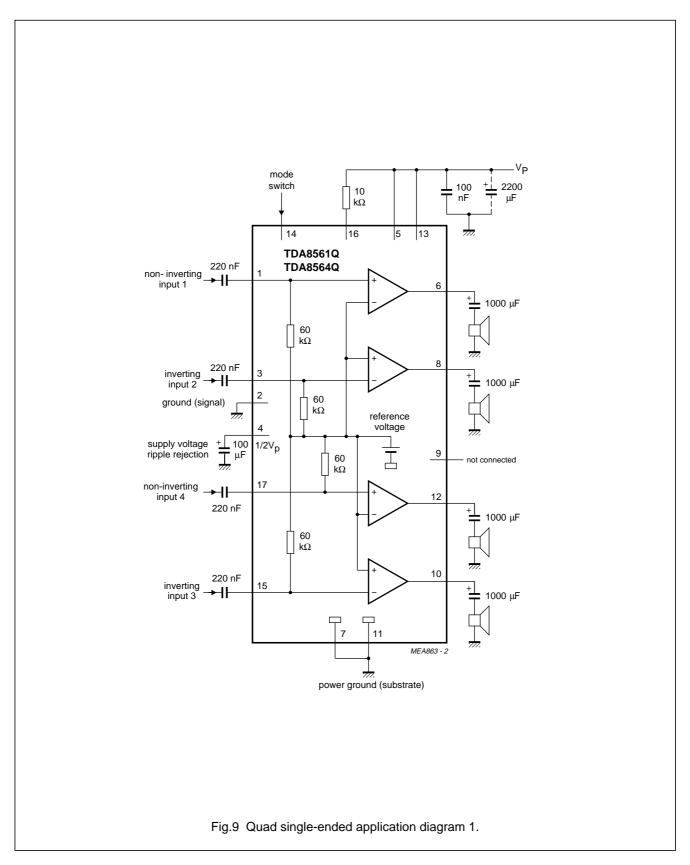
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TEST AND APPLICATION INFORMATION



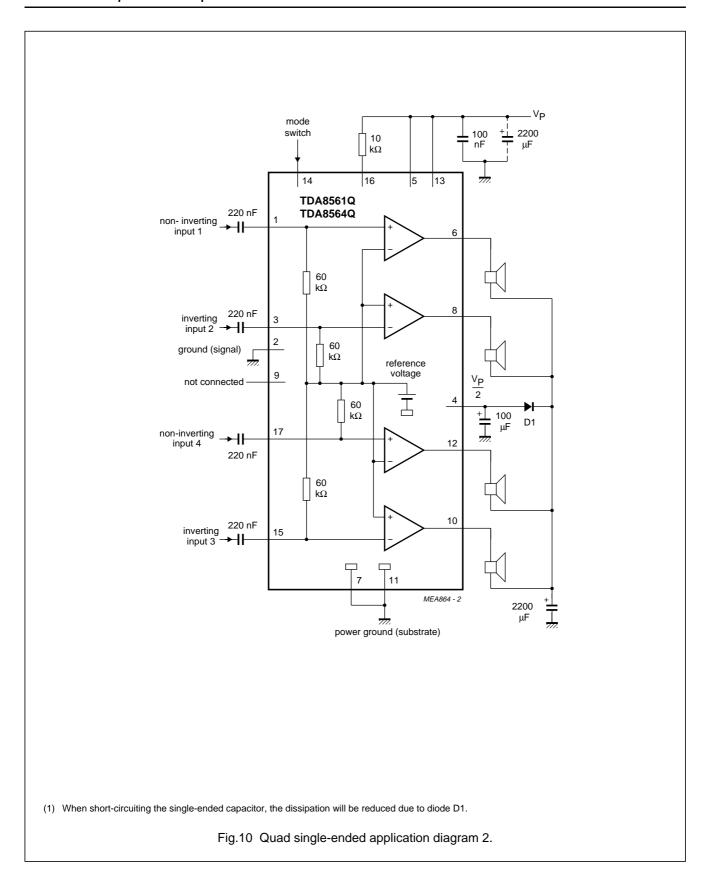
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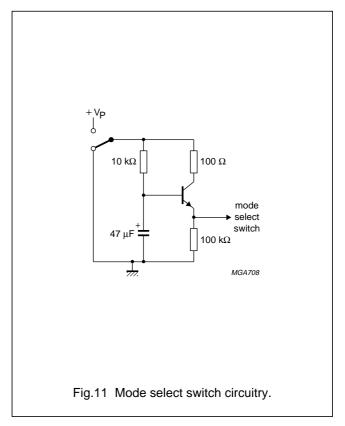
2×24 W BTL or 4×12 W single-ended car radio power amplifier

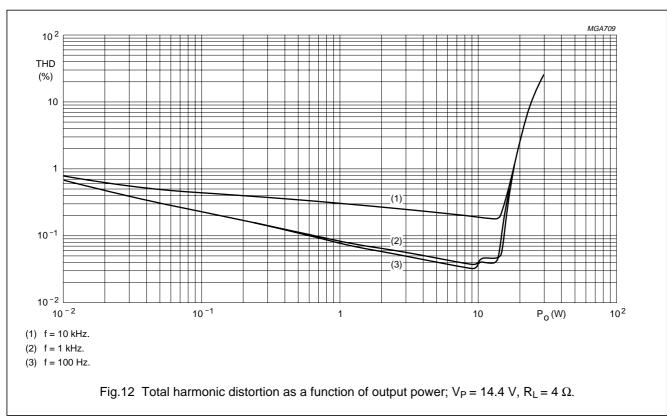
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Mode select switch

To avoid switch-on plops, it is advised to keep the amplifier in the mute mode during >100 ms (charging of the input capacitors at pins 1, 3, 15 and 17.

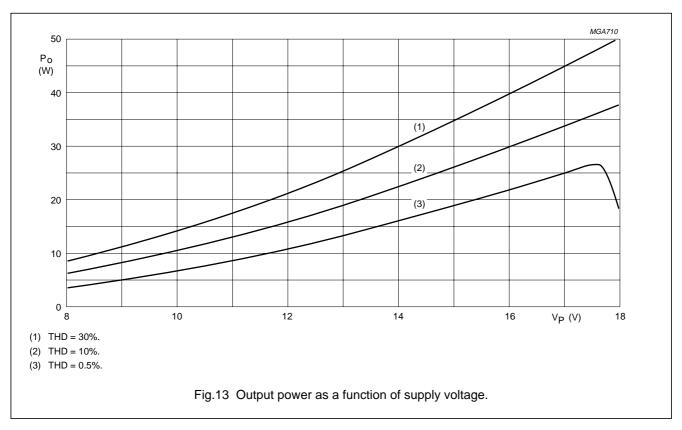
The circuit in Fig.11 slowly ramps up the voltage at the mode select switch pin when switching on and results in fast muting when switching off.

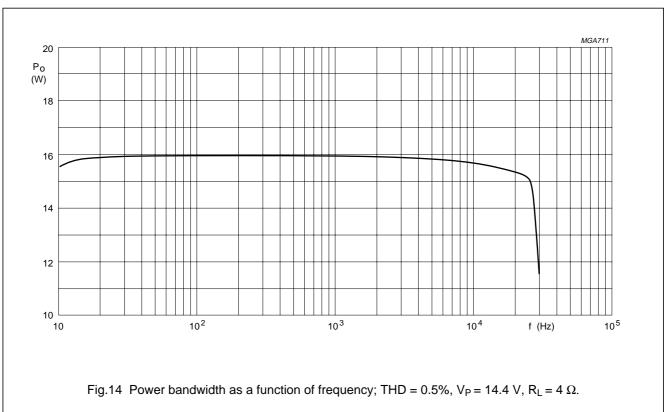




2×24 W BTL or 4×12 W single-ended car radio power amplifier

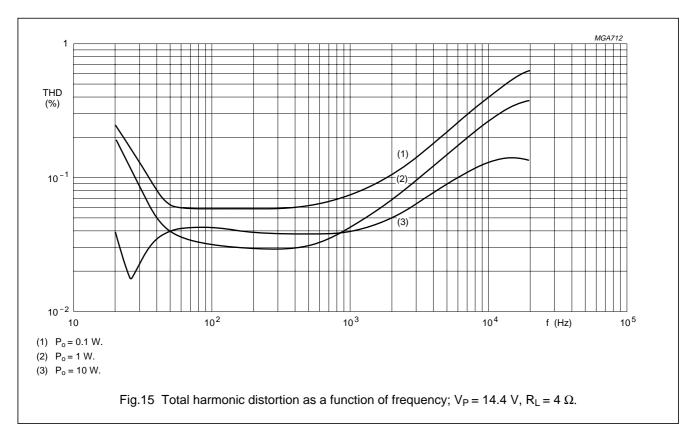
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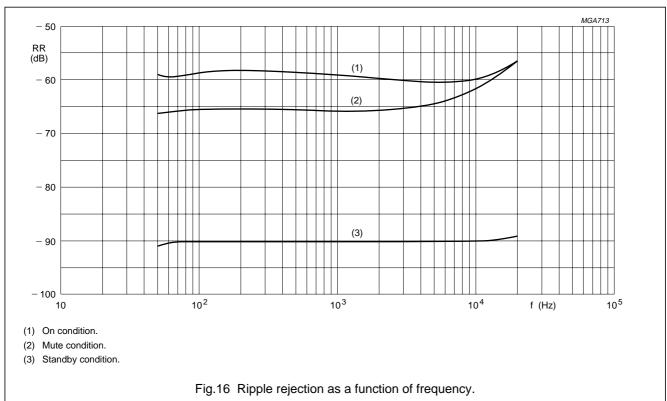




2×24 W BTL or 4×12 W single-ended car radio power amplifier

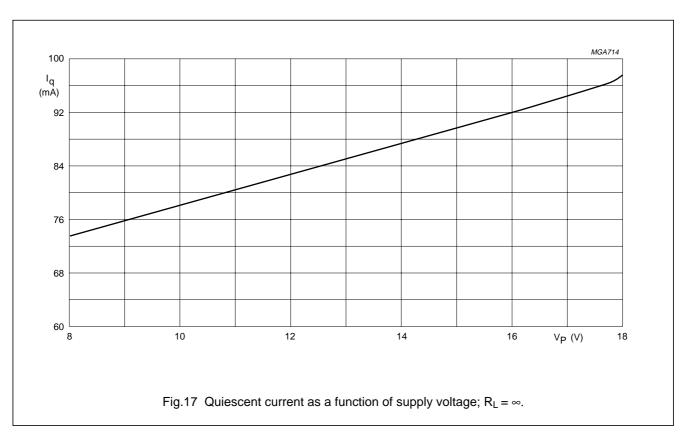
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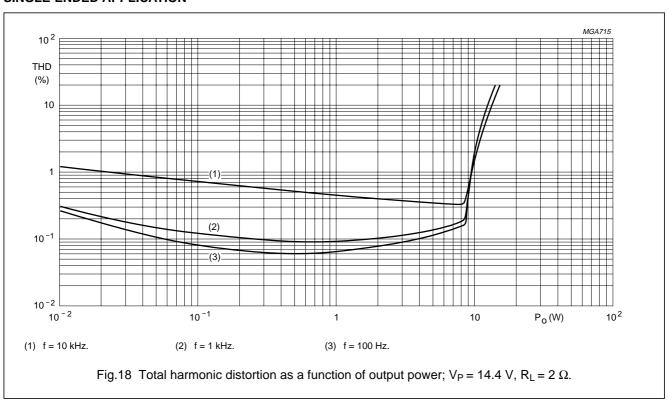


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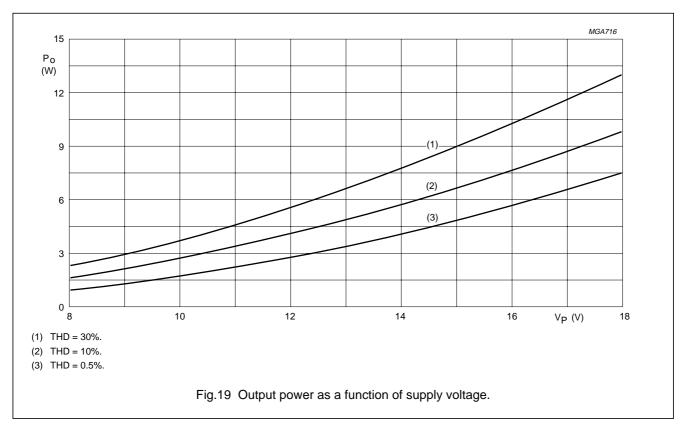


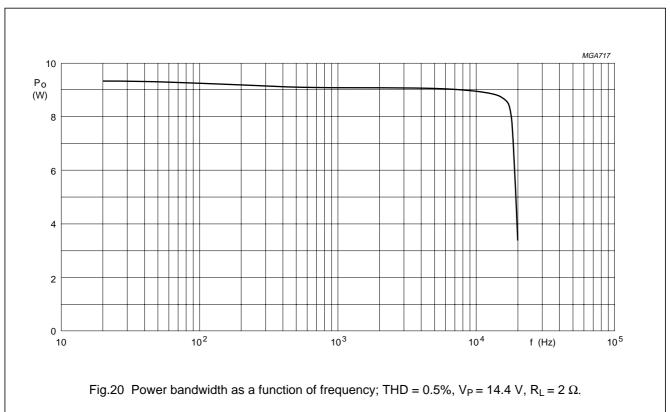
SINGLE-ENDED APPLICATION



2×24 W BTL or 4×12 W single-ended car radio power amplifier

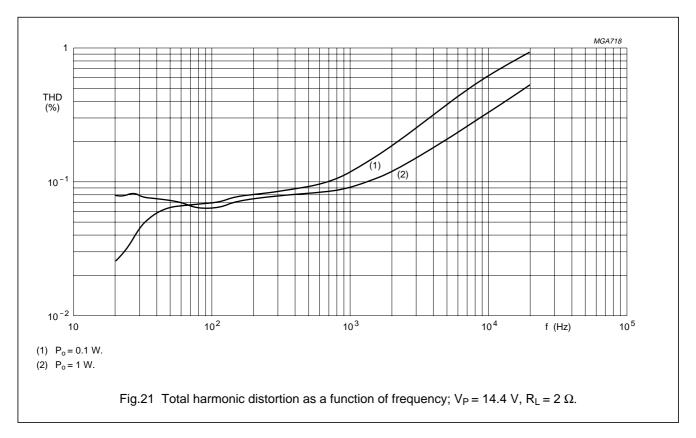
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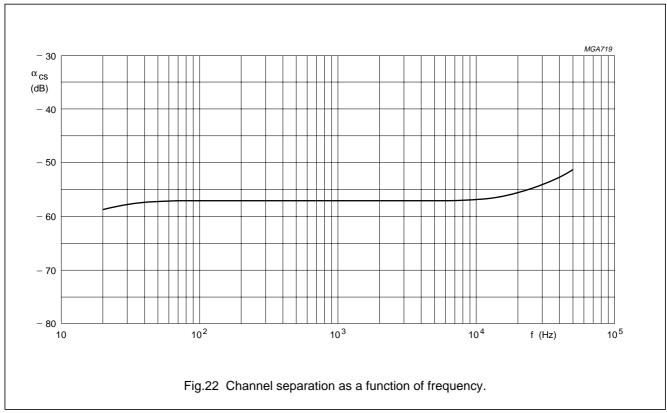




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BTL APPLICATION

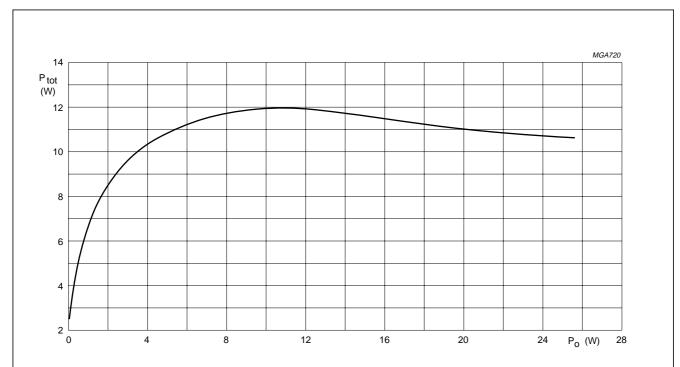


Fig.23 Total power dissipation as a function of output power; $V_P = 14.4 \text{ V}$, $R_L = 4 \Omega$ (1 channel driven BTL or 4 channels in single-ended mode).

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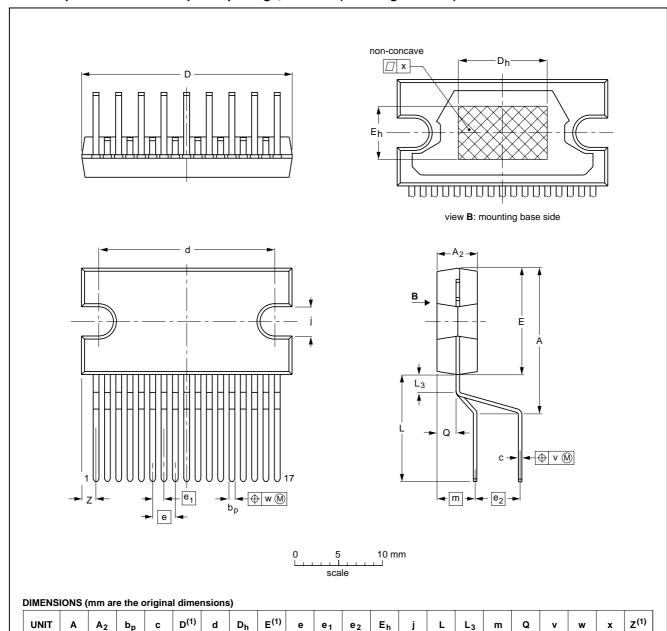
PACKAGE OUTLINE

DBS17P: plastic DIL-bent-SIL power package; 17 leads (lead length 12 mm)

SOT243-1

2.00 1.45

0.03



Note

17.0

15.5

4.6 4.2

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

24.0 23.6 20.0

19.6

12.2 11.8

2.54

1.27

5.08

10

0.48 0.38

0.75

0.60

OUTLINE		REFERENCES			EUROPEAN ISSUE DATI	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT243-1						95-03-11 97-12-16

12.4 11.0

2.4

1.6

4.3

8.0

3.4

3.1

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SOLDERING

Introduction to soldering through-hole mount packages

This text gives a brief insight to wave, dip and manual soldering. A more in-depth account of soldering ICs can be found in our "Data Handbook IC26; Integrated Circuit Packages" (document order number 9398 652 90011).

Wave soldering is the preferred method for mounting of through-hole mount IC packages on a printed-circuit board.

Soldering by dipping or by solder wave

The maximum permissible temperature of the solder is 260 °C; solder at this temperature must not be in contact with the joints for more than 5 seconds.

The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ($T_{stg(max)}$). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

Manual soldering

Apply the soldering iron (24 V or less) to the lead(s) of the package, either below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

Suitability of through-hole mount IC packages for dipping and wave soldering methods

PACKAGE	SOLDERING METHOD		
PACKAGE	DIPPING	WAVE	
DBS, DIP, HDIP, SDIP, SIL	suitable	suitable ⁽¹⁾	

Note

1. For SDIP packages, the longitudinal axis must be parallel to the transport direction of the printed-circuit board.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
more of the limiting values of the device at these or at	accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or may cause permanent damage to the device. These are stress ratings only and operation any other conditions above those given in the Characteristics sections of the specification limiting values for extended periods may affect device reliability.
Application information	
Where application informat	on is given, it is advisory and does not form part of the specification.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

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